SMF3.3

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Agency Approvals

AGENCY	AGENCY FILE NUMBER
91	E230531

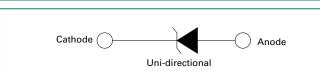
Maximum Ratings and Thermal Characteristics (T₄=25°C unless otherwise noted)

Parameter		Symbol	Value	Unit
Peak Pulse Power	8/20µs	р	1200	W
Dissipation at T _A =25°C (Note 1)	10/1000µs	P _{PPM}	200	W
Thermal Resistance Ambient	e Junction- to-	R _{eja}	220	°C/W
Thermal Resistanc	e Junction- to- Lead	$R_{_{\theta JL}}$	100	°C/W
Operating Temper	ature Range	TJ	-55 to 150	°C
Storage Temperatu	ire Range	T _{stg}	-55 to 150	°C

Notes:

1. Non-repetitive current pulse, per Fig. 4 & 6 and derated above T, (initial) =25°C per Fig. 3.

Functional Diagram



Description

SMF3.3 is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

Features

- 200W peak pulse power capability at 10/1000µs waveform, repetition rate (duty cycle): 0.01%
- 1200W peak pulse power capability at 8/20us waveform
- Excellent clamping capability
- Compatible with industrial standard package SOD-123FL
- Low profile: maximum height of 1.08mm.
- For surface mounted applications to optimize board space
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- IEC-61000-4-2 ESD 30kV(Air), 30kV (Contact)

ESD protection of data lines in accordance with IEC 61000-4-2

- EFT protection of data lines in accordance with IEC 61000-4-4
- Fast response time: typically less than 1.0ns from 0 Volts to V_{BR} min
- High temperature soldering: 260°C/40 seconds at terminals
- Built-in strain relief
- Meet MSL level1, per J-STD-020C, LF maximun peak of 260°C
- Matte tin lead-free plated
- Halogen-free and RoHS compliant
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/ JEDEC J-STD-609A.01)

Applications

SMF3.3 devices are ideal for the protection of portable devices/hard drives, notebooks, V_{cc} busses, POS terminal, SSDs, power supplies, monitors, and vulnerable circuit used in other consumer applications.

Electrica	al Charact	teristics	์ (T _A =25°C เ	unless other	wise noted)					
Part Number	Marking Code	Voltaç	down ge V _{BR} a) @ I _T	Test Current	Reverse Stand off Voltage V _e	Maximum Reverse Leakage @ V₅	Maximum Peak Pulse Current	Maximum Clamping Voltage @l	Maximum Peak Pulse Current	Maximum Clamping Voltage @l
		MIN	MAX	'⊤ (mA)	(V)	I _R (μΑ)	(10/1000µS) I _{pp} (A)	(10/1000µŠ) V _c (V)	(8/20µS) I _{pp} (A)	(8/20µS) [⊷] V _c (V)
SMF3.3	33	3.4	4.3	10	3.3	0.5	30.0	6.8	120.0	10.0

Notes:

 V_{pp} measured after I_T applied for 300µs, I_T = sequare wave pulse or equivalent.

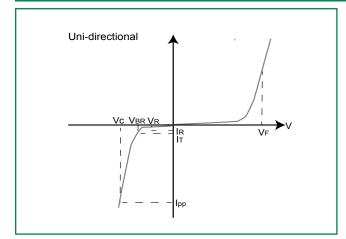
Surge current waveform per 10/1000µs exponential wave and derated per Fig.2.

All terms and symbols are consistent with ANSI/IEEE C62.35.
 Surge current waveform per 8/20µs exponential wave and derated per Fig.6

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I-V Curve Characteristics



- $\textbf{P}_{_{\textbf{PPM}}}$ Peak Pulse Power Dissipation Max power dissipation
- $\mathbf{V}_{_{\!R}}$ **Stand-off Voltage** Maximum voltage that can be applied to the TVS without operation
- V_{BR} Breakdown Voltage -- Maximum voltage that flows though the TVS at a specified test current (I,)
- V_c Clamping Voltage Peak voltage measured across the TVS at a specified lppm (peak impulse current)
- ${\boldsymbol{I}}_{\!\scriptscriptstyle \rm R}$ Reverse Leakage Current -- Current measured at $V_{\!\scriptscriptstyle \rm R}$
- V_F Forward Voltage Drop for Uni-directional

note: V_{E} distribution range from 10V to 15V

Ratings and Characteristic Curves (T_A=25°C unless otherwise noted)

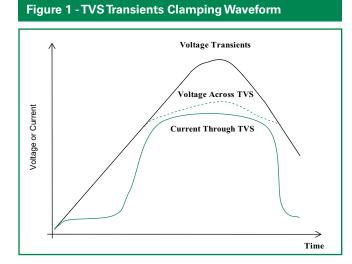


Figure 3 - Peak Pulse Power Derating Curve

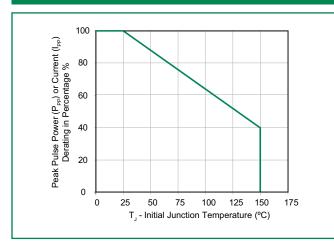


Figure 2 - Peak Pulse Power Rating Curve

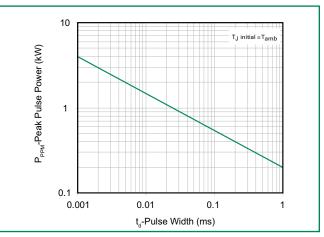
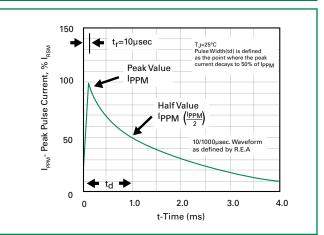


Figure 4 - 10/1000µS Pulse Waveform



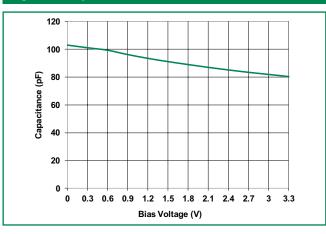
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Surface Mount – 200W > SMF3.3 Series

Figure 5 - Capacitance vs. Reverse Bias

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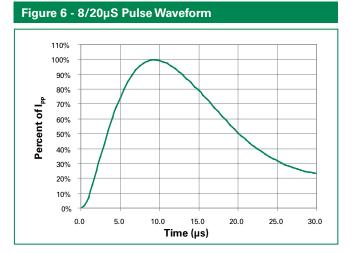


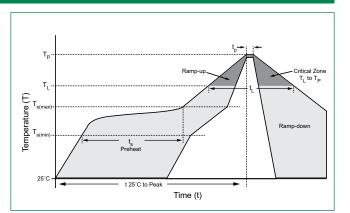
Soldering Parameters

Reflow Co	ndition	Lead–free assembly
	-Temperature Min (T _{s(min)})	150°C
Pre Heat	-Temperature Max (T _{s(max)})	200°C
	-Time (min to max) (t _s)	60 – 180 secs
Average ra to peak	mp up rate (Liquidus Temp (T _A)	3°C/second max
$T_{S(max)}$ to T_A	- Ramp-up Rate	3°C/second max
Reflow	-Temperature (T _A) (Liquidus)	217°C
nellow	-Time (min to max) (t _s)	60 – 150 seconds
Peak Temp	erature (T _P)	260+0/-5 °C
Time withi Temperatu	n 5°C of actual peak re (t _p)	20 – 40 seconds
Ramp-dow	n Rate	6°C/second max
Time 25°C	to peak Temperature (T _P)	8 minutes Max.
Do not exc	eed	260°C

Physical Specifications

Case	SOD-123FL plastic over passivated junction
Polarity	Color band denotes cathode except bipolar
Terminal	Matte tin-plated leads, solderable per JESD22-B102





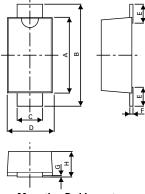
High Reliability Test Specification

Pre-condition (HTRB/TC/ PCT/ H3TRB)	 (1) Bake 24hrs @150°C (2)168hrs @85% RH and 85°C (3) I_R reflow,3 reflows, peak temperature of 260°C
HTRB	JESD 22-108C V _{cc} bias= 80%V _{DRM} &T _A =150°C, 1008hrs
Temperature Cycling	MIL-STD-883F, Method 1010.8 Condition C -65°C to150°C, 1000 cycles
Pressure Cooker	JEDEC 22-A102C 100%RH @121°C @15psi, 96hrs
Bias Humidity (H3TRB)	JESD 22-A101B Vcc bias (pin1to pin3)=V _{DRM} ,85%RH, 85°C , 1008 hours
RSH	JESD 22-A111 260°C ,10 secs.

TVS Diodes Surface Mount – 200W > SMF3.3 Series



Dimensions - SOD-123FL Package



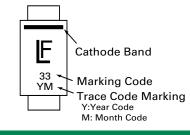
Dimensions	Millim	neters	Inches	
Dimensions	Min	Max	Min	Max
А	2.90	3.10	0.114	0.122
В	3.50	3.90	0.138	0.154
С	0.85	1.05	0.033	0.041
D	1.70	2.00	0.067	0.079
E	0.43	0.83	0.017	0.033
F	0.10	0.25	0.004	0.010
G	0.00	0.10	0.000	0.004
Н	0.90	1.08	0.035	0.043

Mounting Pad Layout

 $V_{\rm R}$ VOLTAGE



Part Marking System



Packaging Options

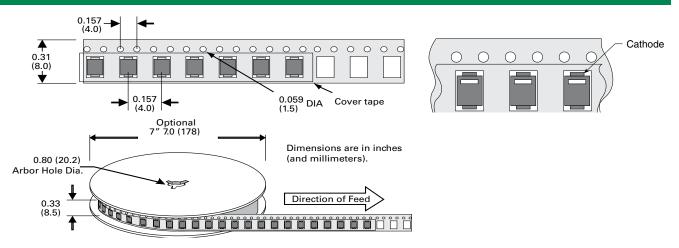
- SERIES

Part Numbering System

SMF 3.3

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
SMF3.3	SOD-123FL	3000	Tape & Reel – 8mm tape/7" reel	EIA RS-481





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